

Factory Prog. 5 Output CMOS TCXO

- Full Custom Multi-Frequency Programmable Osc
- Reduced EMI by turning off unused output
- Factory Programmable
- Industry-standard packaging saves on board space
- Mult. outputs 1 pkg vs. mult. osc & assoc. comp.
- Performs well under all conditions
- Increased Integration

Applications

- High-end multimedia
- Communications
- Industrial
- A/D converters
- Consumer Applications
- Low tolerance applications
- Low-power applications

Series **CCT5C**

Part Numbering Example: **CCT5C 1A 200.0 / 150.0 / 125.0 / 100.0 / 75.0**

| | | | | | | |
|---------------|---------------------------------|--------------------|--------------------|--------------------|--------------------|--------------------|
| CCT5C | 1A | 200 | 150 | 125 | 100 | 75 |
| SERIES | PACKAGE STYLE | FREQUENCY A | FREQUENCY B | FREQUENCY C | FREQUENCY D | FREQUENCY E |
| | 1A=14 pin dip 9=9.6x11.4 SMD | 0.2 - 200 MHz | 0.2 - 200 MHz | 0.2 - 200 MHz | 0.2 - 200 MHz | 25 - 200 MHz |

| Specifications: | Min | Typ | Max | Unit |
|---|--------------------------|-----|----------|---------------|
| Frequency Range: | | | | |
| Output A CMOS | 0.2 | | 200 | MHz |
| Output B CMOS | 0.2 | | 200 | MHz |
| Output C CMOS | 0.2 | | 200 | MHz |
| Output D CMOS | 0.2 | | 200 | MHz |
| Output E CMOS | 25 | | 200 | MHz |
| Available Stability Options: | -2.5 | | 2.5 | ppm |
| Supply Voltage: | 3.135 | 3.3 | 3.465 | V |
| Operating Temperature Range Options: | -40 | | 85 | °C |
| Storage Temperature: | -55 | | 125 | °C |
| Duty Cycle: | 40 45 | | 60 55 | % % |
| Start-Up Time: | | 3 | 10 | mS |
| Aging (PPM/1st Year): Ta=25C, Vdd=3.3V | | | ±1 | ppm |
| Static Discharge Voltage Mil-Std 883, method 3015 | 2000 | | | V |
| Output Load: CMOS, < 40 MHz CMOS, ≥ 40 MHz | | | 30 15 | pF pF |
| Output Level: | CMOS | | | |
| Packaging: | 25 / Tube Tape & Reel | | | 14 pin SMD |

Notes: Recommended .01 µF bypass capacitor from Vcc to GND. Capacitor should be as close to oscillator as possible.

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Rev: M-090414-14
Downloaded from [Elseedia.com](http://www.Elseedia.com) electronic components distributor



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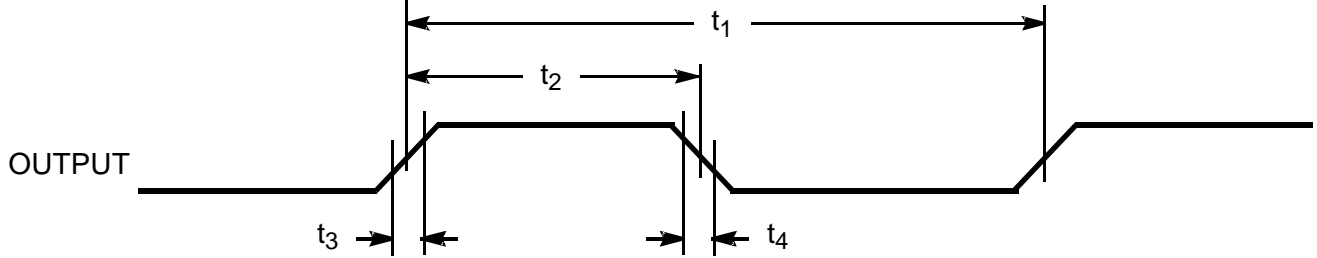
Electrical Characteristics

| DESCRIPTION | | CONDITIONS | MIN | TYP | MAX | UNIT |
|-------------|----------------------------|---|-----|-----|-----|------|
| Ioh | Output High Current | Voh = (L)Vdd - 0.5, (L)Vdd = 3.3 V | 12 | 24 | | mA |
| Iol | Output Low Current | Vol = .5, (L)Vdd = 3.3 V | 12 | 24 | | mA |
| Vih | High Level Input Voltage | CMOS levels, % of Vdd | 0.7 | | | V |
| Vil | Low-Level Input Voltage | CMOS levels, % of Vdd | | | 0.3 | V |
| Iih | Input High Current | Vin = AVdd - 0.3 V | | <1 | 10 | μA |
| Iil | Input Low Current | Vin = + 0.3 V | | <1 | 10 | μA |
| Ioz | Output Leakage Current | tri-state outputs | | | 10 | μA |
| Idd | Total Power Supply Current | Example 1: 1 output@200 MHz; 1 output@66.666 MHz 1 output@100 MHz; 1 output@50 MHz 1 output@25 MHz Example 2: 1 output@200 Mhz; 1 output@155.52 MHz 1 output@100 Mhz; 1 output@77.76 MHz 1 output@50 Mhz | | 35 | | mA |
| | | | | 39 | | mA |
| Idds | Shutdown Power Supply Curr | Shutdown active | | 5 | 20 | μA |

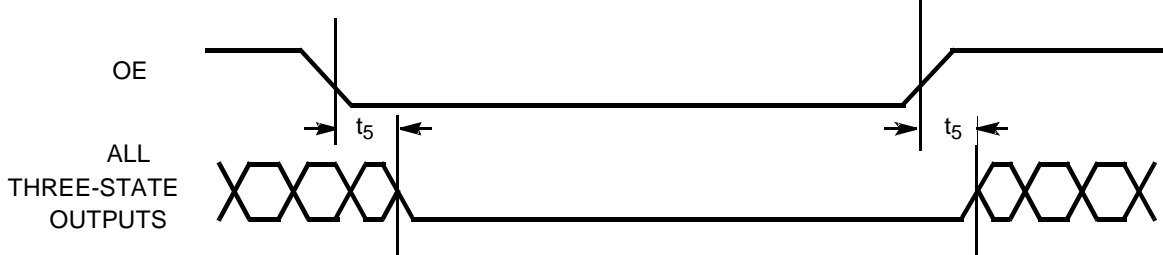
Output Clock Switching Characteristics

| DESCRIPTION | | CONDITIONS | MIN | TYP | MAX | UNIT |
|-------------|--|---|------|-----|-----|------|
| 1/t1 | Output Frequency | Clock output limit, CMOS, Commercial | | | 200 | MHz |
| t3 | Rising Edge Slew Rate | Output clock rise time, 20% – 80% Vdd | 0.75 | 1.4 | | nS |
| t4 | Falling Edge Slew Rate | Output clock fall time, 20% – 80% Vdd | 0.75 | 1.4 | | nS |
| t5 | Output tri-state timing after SD/OE switches | Time for output to enter/leave tri-state mode | | 150 | 300 | nS |
| t6 | Clock Jitter measured at Vdd/2 | Peak-to-Peak period jitter, CLK outputs | | 200 | | pS |

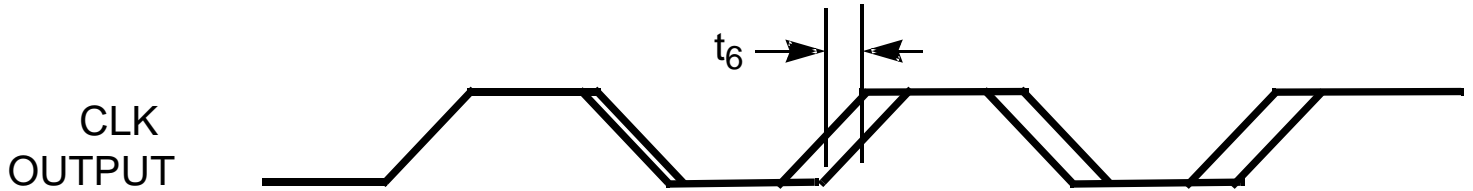
ALL OUTPUTS, DUTY CYCLE, RISE/FALL TIME



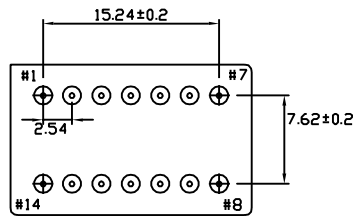
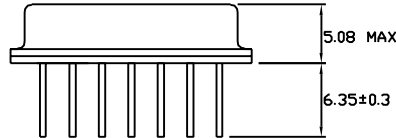
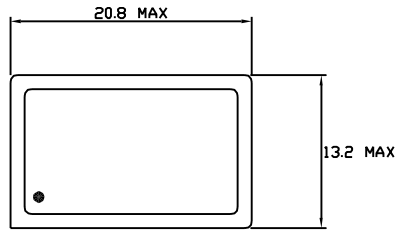
OUTPUT 3-STATE TIMING



CLK OUTPUT JITTER



DIP

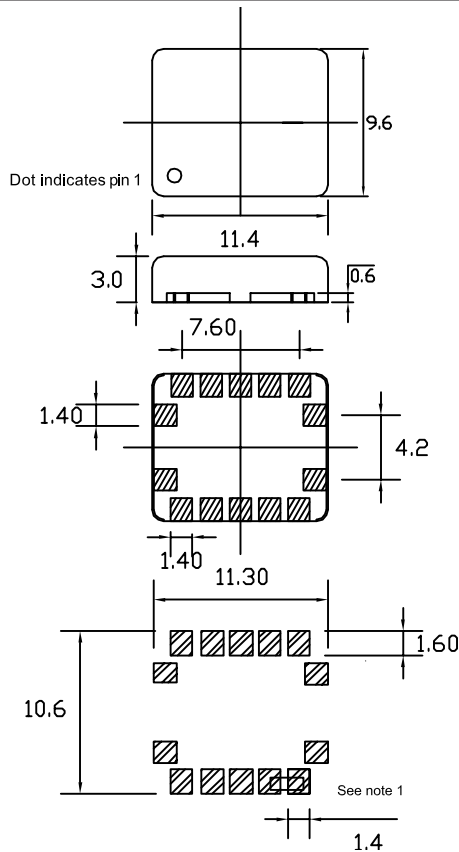


Dimensions are in mm

PIN FUNCTION

- PIN 1 OE (CONNECT TO VDD)
- PIN 2 SUSPEND (CONNECT TO GND)
- PIN 3 VDD
- PIN 4 CLK C OUTPUT
- PIN 5 CONNECT TO PIN 6
- PIN 6 CONNECT TO PIN 5
- PIN 7 GND
- PIN 8 FACTORY USE (MAKE NO CONNECTION)
- PIN 9 CLK D OUTPUT
- PIN 10 CLK E OUTPUT
- PIN 11 FACTORY USE (MAKE NO CONNECTION)
- PIN 12 FACTORY USE (MAKE NO CONNECTION)
- PIN 13 CLK A OUTPUT
- PIN 14 CLK B OUTPUT

SMD



PIN FUNCTION

- PIN 1 FACTORY USE (MAKE NO CONNECTION)
- PIN 2 OE
- PIN 3 VDD
- PIN 4 CLK C OUTPUT
- PIN 5 CONNECT TO PIN 6
- PIN 6 CONNECT TO PIN 5
- PIN 7 GND
- PIN 8 FACTORY USE (MAKE NO CONNECTION)
- PIN 9 CLK D OUTPUT
- PIN 10 CLK E OUTPUT
- PIN 11 FACTORY USE (MAKE NO CONNECTION)
- PIN 12 FACTORY USE (MAKE NO CONNECTION)
- PIN 13 CLK A OUTPUT
- PIN 14 CLK B OUTPUT

Dimensions in mm
Recommended solder pad layout

Note1:
For proper operation pin 5 must be connected to pin 6

